



Micron's Hybrid Memory Cube Wins The Linley Group Analysts' Choice Award

January 25, 2012 at 12:00 AM EST

BOISE, Idaho, Jan. 25, 2012 (GLOBE NEWSWIRE) -- Micron (Nasdaq:MU) announced today that its Hybrid Memory Cube (HMC) was chosen as a winner of The Linley Group's first annual Analysts' Choice Awards. The Hybrid Memory Cube won the award for Best Technology of 2011.

The Analysts' Choice Awards recognize the top microprocessor-related products of 2011 in several major categories, including embedded, mobile, PC, server, design IP and related technologies. For the Best Technology Award, The Linley Group's team of technology analysts considered merits of the leading, forward-looking technologies that were announced during 2011.

"Our analysts are deeply familiar with processor products and technology, having conducted extensive research in order to deliver the firm's popular publications and reports," said Linley Gwennap, founder and principal analyst at The Linley Group. "We chose the winners on the basis of their performance, power, features and cost, as appropriate for their target applications."

"Hybrid Memory Cubes promise greater density, lower latency, higher bandwidth, and better power efficiency per bit compared with conventional memories," said Tom R. Halfhill, a senior analyst at The Linley Group. "Early benchmarks show a memory cube blasting data 12 times faster than DDR3-1333 SDRAM while using only about 10 percent of the power."

HMC technology uses advanced through-silicon vias (TSVs) — vertical conduits that electrically connect a stack of individual chips — to combine high-performance logic with Micron's state-of-the-art DRAM. HMC delivers bandwidth and efficiencies a leap beyond current device capabilities. HMC prototypes, for example, clock in with bandwidth of 128 gigabytes per second (GB/s). By comparison, current state-of-the-art devices deliver 12.8 GB/s. HMC also requires 70 percent less energy to transfer data while offering a small form factor— just 10 percent of the footprint of conventional memory.

HMC will enable a new generation of performance in applications ranging from large-scale networking and high-performance computing, to industrial automation and, eventually, consumer products.

"With so many other great innovations out there, we're especially honored to receive this prestigious award from The Linley Group. This world-class recognition is a reflection on the team that is working to match processors with memory and break down the memory wall by bringing the Hybrid Memory Cube to the market," said Brian Shirley, vice president for Micron's DRAM Solutions Group. "Special thanks to the Micron engineers who've designed this breakthrough architecture, and to our esteemed colleagues in the industry who are helping to expedite the specifications and manufacturing for this revolutionary technology."

The Linley Group has initiated the awards program to honor excellence in processor design and innovation and to recognize the processor products it believes will have the greatest impact on next-generation system design. The Linley Group publishes Microprocessor Report, the industry's leading newsletter, and other technology reports. For more information about this award, please visit: www.linleygroup.com

Additional information, technical specifications, tools and support for adopting HMC technology can be found at micron.com.

Relevant Links

Stay up-to-date on Micron news with these easy tools:

- Micron Innovations Blog: www.micronblogs.com < <http://www.micronblogs.com> >
- Micron on Twitter: <http://twitter.com/microntechnews> < <http://twitter.com/microntechnews> >
- Micron Pressroom: www.micron.com/media < <http://www.micron.com/media> >

About Micron

Micron Technology, Inc., is one of the world's leading providers of advanced semiconductor solutions. Through its worldwide operations, Micron manufactures and markets a full range of DRAM, NAND and NOR flash memory, as well as other innovative memory technologies, packaging solutions and semiconductor systems for use in leading-edge computing, consumer, networking, embedded and mobile products. Micron's common stock is traded on the NASDAQ under the MU symbol. To learn more about Micron Technology, Inc., visit www.micron.com.

The Micron Technology, Inc. logo is available at <http://www.globenewswire.com/newsroom/prs/?pkgid=6950>

©2012 Micron Technology, Inc. All rights reserved. Information is subject to change without notice. Micron and the Micron orbit logo are trademarks of Micron Technology, Inc. All other trademarks are the property of their respective owners.

CONTACT: Scott Stevens

Micron Technology, Inc.

512-288-4050 ☐

sstevens@micron.com

